JAN 13 2004

In re A	Application of:)		
	IMI SUGAYA))		
)	Art Unit:	1722
Applic	cation No. 10/037,062)	Evaminer:	NGUYEN, THU KHANH T.
Filed:	October 19, 2001)	Exammer.	induten, Thu Mhami 1.
For:	DIE FOR DIE COMPACTING OF)		
	POWDERED MATERIAL)		

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

FIRST RESPONSE

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Responsive to the Office action dated October 3, 2003 in the patent application identified above, please enter the following amendments and reconsider the application in view of the appended remarks.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450 on January 5, 2004